PCN Number:   20170614007   PCN Date:   June 16, 2017     Title:   Datasheet for LVC1G14-Q1     Dept:   Quality Services   Change Type:     Assembly Site   Design   Wafer Bump Site   Assembly Process   Data Sheet   Wafer Bump Material   Assembly Process   Data Sheet   Wafer Bump Material   Assembly Materials   Part number change   Wafer Bump Process   Packing/Shipping/Labeling   Test Process   Wafer Fab Materials   Packing/Shipping/Labeling   Test Process   Wafer Fab Materials   Wafer Fab Process   Wafer Fab Materials				1 204					٠.		16 20			
Customer Contact:   PCN Manager   Dept:   Quality Services	PCN Number:				20170614007			PCN Date:	Ju	ne	16, 20	1/		
Assembly Site						_						T		
Assembly Site	Customer Contact: PCN Manager					<u>r</u>				Dej	pt:	Quality Servi	ces	
Assembly Process Assembly Materials  Wafer Fab Site Wafer Fab Materials Wafer Fab Process  Notification Details  Pescription of Change: Texas Instruments Incorporated is announcing an information only notification. The product datasheet(s) is being updated as summarized below. The following change history provides further details.  PIEXAS ANTALVC1G14-Q1 INSTRUMENTS  SITEMAN SOURCE SERBUARY 2015-REVISED MARCH 2017  Changes from Original (February 2015) to Revision A Page  Changed package type to DCK (SC70) and corrected Body Size in Device Information table.  1 Deleted 9 <sub>10</sub> from Absolute Maximum Ratings table. 3 Added Receiving Notification of Documentation Updates section and Community Resources section														
Mechanical Specification    Packing/Shipping/Labeling   Test Site   Wafer Fab Site   Wafer Fab Site   Wafer Fab Site   Wafer Fab Materials   Wafer Fab Ma	Щ									Щ				
Mechanical Specification	Щ					$\boxtimes$								
Packing/Shipping/Labeling   Test Process   Wafer Fab Materials   Wafer Fab Process					Щ									
Notification Details  Description of Change:  Texas Instruments Incorporated is announcing an information only notification. The product datasheet(s) is being updated as summarized below. The following change history provides further details.  TEXAS SN74LVC1G14-Q1  SCESS86A - FEBRUARY 2015 - REVISED MARCH 2017  Changes from Original (February 2015) to Revision A Page  Changed package type to DCK (SC70) and corrected Body Size in Device Information table 1  Deleted θ <sub>JA</sub> from Absolute Maximum Ratings table 3  Added Receiving Notification of Documentation Updates section and Community Resources section 12  The datasheet number will be changing.  Device Family Change From: Change To:  LVC1G14-Q1 SCES865 SCES865A  These changes may be reviewed at the datasheet links provided.  http://www.ti.com/product/SN74LVC1G14-Q1  Reason for Change:  To accurately reflect device characteristics.  Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):  No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.  Changes to product identification resulting from this PCN:  None.  Product Affected:				Щ				$\blacksquare$						
Notification Details  Description of Change:  Texas Instruments Incorporated is announcing an information only notification. The product datasheet(s) is being updated as summarized below. The following change history provides further details.  □ TEXAS SN74LVC1G14-Q1 SCESS865A - FEBRUARY 2015-REVISED MARCH 2017  Changes from Original (February 2015) to Revision A Page  □ Changed package type to DCK (SC70) and corrected Body Size in Device Information table 1 Scesses Added Receiving Notification of Documentation Updates section and Community Resources section 12  The datasheet number will be changing.  Device Family Change From: Change To: LVC1G14-Q1 SCES865 SCES865A  These changes may be reviewed at the datasheet links provided.  http://www.ti.com/product/SN74LVC1G14-Q1  Reason for Change:  To accurately reflect device characteristics.  Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):  No anticipated impact in Fits is a specification change announcement only. There are no changes to the actual device.  Changes to product identification resulting from this PCN:  None.  Product Affected:	Packing/Shipping/Labeling					Ш	Test Process							
Description of Change:  Texas Instruments Incorporated is announcing an information only notification. The product datasheet(s) is being updated as summarized below. The following change history provides further details.  **Texas**  **Texas**  **Texas**  **Instruments**  **Changes from Original (February 2015) to Revision A  **Page**  **Changed package type to DCK (SC70) and corrected Body Size in *Device Information* table**  **Deleted θ <sub>JA</sub> from *Absolute Maximum Ratings table**  **Added Receiving Notification of Documentation Updates section and Community Resources section 12  The datasheet number will be changing.  Device Family  LVC1G14-Q1  SCES865  SCES865A  These changes may be reviewed at the datasheet links provided.  http://www.ti.com/product/SN74LVC1G14-Q1  **Reason for Change:**  To accurately reflect device characteristics.  **Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):*  No anticipated impact impact. This is a specification change announcement only. There are no changes to the actual device.  **Changes to product identification resulting from this PCN:*  None.  **Product Affected:**														
Texas Instruments Incorporated is announcing an information only notification. The product datasheet(s) is being updated as summarized below. The following change history provides further details.  TEXAS SN74LVC1G14-Q1  SCESS865A—FEBRUARY 2015—REVISED MARCH 2017  Changes from Original (February 2015) to Revision A Page  • Changed package type to DCK (SC70) and corrected Body Size in Device Information table 1 • Deleted θ <sub>JA</sub> from Absolute Maximum Ratings table 3 • Added Receiving Notification of Documentation Updates section and Community Resources section 12  The datasheet number will be changing.  Device Family Change From: Change To:  LVC1G14-Q1 SCES865 SCES865A  These changes may be reviewed at the datasheet links provided.  http://www.ti.com/product/SN74LVC1G14-Q1  Reason for Change:  To accurately reflect device characteristics.  Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):  No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.  Changes to product identification resulting from this PCN:  None.  Product Affected:			tion of Cham			IN	otificatio	on Details						
datasheet(s) is being updated as summarized below. The following change history provides further details.   LEXAS INSTRUMENTS  SN74LVC1G14-Q1  SCES885A-FEBRUARY 2015-REVISED MARCH 2017  Changes from Original (February 2015) to Revision A  Page  Changes from Original (February 2015) to Revision A  Page  Changed package type to DCK (SC70) and corrected Body Size in Device Information table  1  Deleted θ <sub>JA</sub> from Absolute Maximum Ratings table  3  Added Receiving Notification of Documentation Updates section and Community Resources section  12  The datasheet number will be changing.  Device Family  Change From:  Change To:  LVC1G14-Q1  SCES865  SCES865A  These changes may be reviewed at the datasheet links provided.  http://www.ti.com/product/SN74LVC1G14-Q1  Reason for Change:  To accurately reflect device characteristics.  Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):  No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.  Changes to product identification resulting from this PCN:  None.  Product Affected:														
Changes from Original (February 2015) to Revision A  Page  Changed package type to DCK (SC70) and corrected Body Size in Device Information table	datasheet(s) is being updated as summarized below. The following change history provides													
Changed package type to DCK (SC70) and corrected Body Size in Device Information table	<b>-</b>	Instruments SN/4LVC1G14-Q1												
<ul> <li>Deleted θ<sub>JA</sub> from Absolute Maximum Ratings table</li></ul>	Ch	Changes from Original (February 2015) to Revision A Page												
<ul> <li>Deleted θ<sub>JA</sub> from Absolute Maximum Ratings table</li></ul>	•	Changed package type to DCK (SC70) and corrected Body Size in Device Information table										1		
Added Receiving Notification of Documentation Updates section and Community Resources section														
The datasheet number will be changing.  Device Family  Change From:  Change To:  LVC1G14-Q1  SCES865  SCES865A  These changes may be reviewed at the datasheet links provided.  http://www.ti.com/product/SN74LVC1G14-Q1  Reason for Change:  To accurately reflect device characteristics.  Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):  No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.  Changes to product identification resulting from this PCN:  None.  Product Affected:		•												
Device Family LVC1G14-Q1 SCES865 SCES865A  These changes may be reviewed at the datasheet links provided. http://www.ti.com/product/SN74LVC1G14-Q1  Reason for Change: To accurately reflect device characteristics.  Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative): No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.  Changes to product identification resulting from this PCN: None.  Product Affected:	• Added Receiving Notification of Documentation Updates section and Community Resources section													
LVC1G14-Q1 SCES865 SCES865A  These changes may be reviewed at the datasheet links provided. <a href="http://www.ti.com/product/SN74LVC1G14-Q1">http://www.ti.com/product/SN74LVC1G14-Q1</a> Reason for Change:  To accurately reflect device characteristics.  Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):  No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.  Changes to product identification resulting from this PCN:  None.  Product Affected:	The	e data	asheet numbe	r will b	e chan	ging	<b>]</b> .							
These changes may be reviewed at the datasheet links provided. <a href="http://www.ti.com/product/SN74LVC1G14-Q1">http://www.ti.com/product/SN74LVC1G14-Q1</a> Reason for Change:  To accurately reflect device characteristics.  Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):  No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.  Changes to product identification resulting from this PCN:  None.  Product Affected:	Device Family						Change I	From:		Cl	hange <sup>-</sup>	To:		
http://www.ti.com/product/SN74LVC1G14-Q1  Reason for Change: To accurately reflect device characteristics.  Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative): No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.  Changes to product identification resulting from this PCN: None.  Product Affected:	LVC1G14-Q1							SCES865			9	SCES865A		
http://www.ti.com/product/SN74LVC1G14-Q1  Reason for Change: To accurately reflect device characteristics.  Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative): No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.  Changes to product identification resulting from this PCN:  None.  Product Affected:	The	These changes may be reviewed at the datasheet links provided												
Reason for Change:  To accurately reflect device characteristics.  Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):  No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.  Changes to product identification resulting from this PCN:  None.  Product Affected:			,					<b>P</b>						
To accurately reflect device characteristics.  Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):  No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.  Changes to product identification resulting from this PCN:  None.  Product Affected:	Inter://www.ti.com/product/SN/4EVC1G14-Q1													
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):  No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.  Changes to product identification resulting from this PCN:  None.  Product Affected:	Re	ason	for Change:											
No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.  Changes to product identification resulting from this PCN:  None.  Product Affected:														
to the actual device.  Changes to product identification resulting from this PCN:  None.  Product Affected:	Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):													
None.  Product Affected:														
Product Affected:	Ch	Changes to product identification resulting from this PCN:												
	Noi	ne.												
SN74LVC1G14QDCKRQ1	Pro	oduc	t Affected:											
	SI	SN74LVC1G14QDCKRQ1												

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com